TMS470M and TMS570 Transportation and Safety MCUs





The TMS470M and TMS570 microcontroller family enables developers to easily create safety-related applications for the transportation industry. TMS470M microcontrollers use the widely adopted ARM® Cortex™-M3 CPU running at 80MHz while the TMS570 microcontrollers integrate dual ARM® Cortex™-R4F floating point processors in lock-step running up to 160MHz. Both series of microcontrollers are qualified to the AEC-Q100 specification and are specifically designed with many integrated safety features that make it easier to certify to automotive and transportation safety standards. There is also a wide range of flash memory configurations, connectivity and control peripherals including CAN, FlexRay, LIN/UART, multi-buffered SPI, multi-buffered Analog to Digital converters and the powerful High End Timer co-processor module (HET).

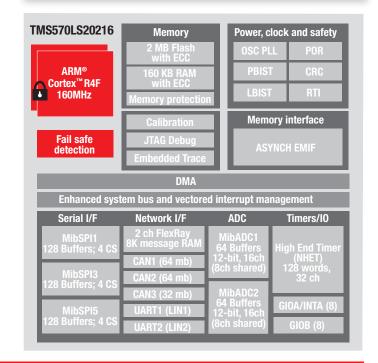
TMS470M

- Efficient 16/32-bit ARM[®] Cortex[™]-M3 CPU available today up to 80MHz
- Developed specifically for safety critical systems needing IEC61508 SIL1 or SIL2 ratings
- Scalable embedded Flash memory options between 256KB to 640KB

TMS470Mx Memory Power, clock and safety **ARM®** Cortex™ M3 80MHz Up to 64KB RAM with ECC Debug/Trace CPU and RAM **Enhanced system bus** Vectored interrupt management Serial I/F Network I/F ADC Timers/IO High End Time (NHET) 64 words, 16ch

TMS570

- High Performance ARM® Cortex[™]-R4F floating-point CPU available today up to 160MHz
- Developed specifically for safety critical systems and IEC61508 SIL3 certified by exida
- Scalable embedded Flash memory options between 1MB and 2MB



TMS470M and TMS570 - A good fit for transportation and safety















Automotive safety systems Hybrids and electric vehicles

Off road vehicles

Railway

Aerospace

TMS470M and TMS570 – Device configurations																
Device	Speed	Flash	RAM	FlexRay	CAN	MibSPI(CS)	UART (LIN)	HET (ch)	MibADC(ch)	EMIF	GIO (Int)	ETM (Data)	RTP (Data)	DMM (Data)	Package	Temp
TMS470MF03107SPZ	80 MHz	256 K	16 kB	_	2	2 (12)	2 (2)	(16)	1 (16)	-	4	_	_	-	100QFP	-40+125C
TMS470MF04207SPZ	80 MHz	384 K	24 kB	-	2	2 (12)	2 (2)	(16)	1 (16)	_	4	-	-	-	100QFP	-40+125C
TMS470MF06607SPZ	80 MHz	512 K	128 kB	-	2	2 (12)	2 (2)	(16)	1 (16)	-	4	-	_	-	100QFP	-40+125C
TMS570LS10106SPGE	140 MHz	1 MB	128 kB		2	3	2 (2)	(25)	2 (20)		8 (8)				144QFP	-40+125C
TMS570LS10106SZWT	160 MHz	1 MB	128 kB	_	3	3	2 (2)	(32)	2 (24)	Yes	16 (8)	(32)	(16)	(16)	337BGA	-40+1250
TMS570LS10116SPGE	140 MHz	1 MB	128 kB	2 ch	2	3	2 (2)	(25)	2 (20)		8 (8)				144QFP	-40+125C
TMS570LS10116SZWT	160 MHz	1 MB	128 kB	2 ch	3	3	2 (2)	(32)	2 (24)	Yes	16 (8)	(32)	(16)	(16)	337BGA	-40+1256
TMS570LS10206SPGE	140 MHz	1 MB	160 kB		2	3	2 (2)	(25)	2 (20)		8 (8)				144QFP	-40+125C
TMS570LS10206SZWT	160 MHz	1 MB	160 kB	_	3	3	2 (2)	(32)	2 (24)	Yes	16 (8)	(32)	(16)	(16)	337BGA	-40+1236
TMS570LS10216SPGE	140 MHz	1 MB	160 kB	2 ch	2	3	2 (2)	(25)	2 (20)		8 (8)				144QFP	-40+125C
TMS570LS10216SZWT	160 MHz	1 MB	160 kB	2 ch	3	3	2 (2)	(32)	2 (24)	Yes	16 (8)	(32)	(16)	(16)	337BGA	-40+1236
TMS570LS20206SPGE	140 MHz	2 MB	160 kB		2	3	2 (2)	(25)	2 (20)		8 (8)				144QFP	40 . 1050
TMS570LS20206SZWT	160 MHz	2 MB	160 kB	_	3	3	2 (2)	(32)	2 (24)	Yes	16 (8)	(32)	(16)	(16)	337BGA	-40+125C
TMS570LS20216SPGE	140 MHz	2 MB	160 kB	2 ch	2	3	2 (2)	(25)	2 (20)		8 (8)				144QFP	40 . 1050
TMS570LS20216SZWT	160 MHz	2 MB	160 kB	2 ch	3	3	2 (2)	(32)	2 (24)	Yes	16 (8)	(32)	(16)	(16)	337BGA	-40+125C

Note: For orderable part numbers, replace 'TMS470' with 'S4' and 'TMS570' with 'S5'

TMS470M and TMS570 - Software tools



Program and debug code using Code Composer Studio™ IDE:

- Full featured debugger
- Compiler
- Linker
- Integrated Flash programming



HALCoGen:

- User input on high abstraction level
- Graphical base code generation
- Easy configuration
- Quick start for new projects



Safety MCU demos:

- Safety feature demo
- Ambient light demo
- Temperature sensor demo
- LED light show
- Source Code viewable via CCS

Other software and tools:

- HET IDE
- PLL calculators
- ECC generator tools
- nowFlash Flash programming tool
- RTOS support

Development kits

USB Development Stick Kits:

- TMS470M = TMDX470MF066USB; TMS570 = TMDX570LS20SUSB
- USB powered
- On board USB XDS100v2 JTAG debug
- On board SCI to PC serial communication
- Access to select signal pin test points
- CAN transceiver
- LEDs, temp sensor, light sensor
- QFP packaged MCU

Full Featured Development Kits:

- TMS570 = **TMDX570LS20SMDK**
- On board USB XDS100v2 JTAG debug
- External high speed emulation via JTAG
- On board SCI to PC serial communication
- Access to signal pin test points
- CAN, LIN and FlexRay transceivers
- · LEDs, temp sensor, light sensor



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